Fabrication and characteristics of Hg/n-bulk GaN schottky diode

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Abstract
In this work, the electrical characteristics of bulk gallium nitride doped n have been investigated by the current–voltage (I–V) and capacitance-voltage (C-V) at 300 K temperature. Using the thermionic emission theory, the saturation current, IS (2.45×10⁻⁷ A), the ideality factor n (1.13), the barrier height ϕbn (0.65) and the serial resistance RS (670) are determined for our structure (Hg/n-GaN). It has also been calculated the barrier height from C–V experimental data. The determined value is higher (1.24 eV) compared with the value obtained from I–V (0.65 eV) characteristics, it was found the following electrical parameters, doping concentration (ND = 1.68×10¹⁶ cm⁻³), diffusion voltage (Vd = 1.11 V) and density of interface states (Nss).

Keywords
Electrical Characteristics; Bulk GaN; Shottky; Diode, Barrier; Height; Density of Interface States
**Introduction**

GaN is the most popular material in this field of research. These electrical, electronic and mechanical properties make him the best candidate in the field of high frequency power electronics and optoelectronics [1-3]. Various studies have shown that devices made of GaN exhibit better performance than those based on conventional semiconductors although the GaN contains a high density of defects produced during its development.

To reduce the density of defect layers in GaN, studies are being undertaken to look for the best technique to develop a defect-free GaN.

The latest guidance is that which consists in the bulk GaN. Some have resulted in obtaining bulk GaN but improvements are needed to optimize and monetize the different techniques. Some parameters of Schottky diode such as barrier height, doping concentration and diffusion potential can be derived from $C^{-2} (V)$ relationship [4, 5]

The purpose of this paper is to realize and characterize Schottky diodes based on bulk GaN, there have been investigated the different electrical parameters determined from (I-V) and (C-V) characteristics of the Hg /n-GaN structure. From the forward bias current–voltage (I–V) characteristics, we have determined the saturation current ($I_s$), the ideality factor ($n$), the Schottky barrier height ($\phi_{bs}$) and the series resistance ($R_s$). Capacitance-voltage (C-V) measurements also have given detailed information about Schottky contacts.

**Material and method**

The bulk GaN is used as an n-type unintentionally doped Lumilog, the growth technique used is the HVPE (Hybrid Vapor Phase Epitaxy) freestanding GaN.

Deposition of ohmic contact is on the rear side using the coating of silver (Ag) and the Schottky contact deposited sue the front face is a temporary drop Mercury (Hg), the surface is 1 mm in diameter.

The following figure illustrates the pattern of the sample obtained after the deposition of Ohmic contacts and Schottky (see Figure 1).
The I–V measurement was investigated using a conventional method. The electrical current was measured using a HP4155B instrument at room temperature and in the dark.

The C–V measurement was obtained using a KEITHLEY test system 590 CV Analyser, by applying a DC between −4 V and 0 V with 1 MHz frequency, so that the interface states are unable to respond to the AC signal.

Table 1. Classic parameters of GaN at 300 k [6]

<table>
<thead>
<tr>
<th>Parameters</th>
<th>Values (units of measurements)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Effective density of electrons in the conduction band (N_c)</td>
<td>(2.6 \times 10^{18} \text{cm}^{-3})</td>
</tr>
<tr>
<td>Effective density of electrons in the valence band (N_v)</td>
<td>(2.5 \times 10^{18} \text{cm}^{-3})</td>
</tr>
<tr>
<td>Width of the band gap (E_g)</td>
<td>3.437 eV</td>
</tr>
<tr>
<td>The electron affinity (\chi)GaN</td>
<td>4.1 eV</td>
</tr>
<tr>
<td>Dielectric constant (\varepsilon)GaN</td>
<td>9.5</td>
</tr>
<tr>
<td>Electron mobility (\mu)</td>
<td>1000 \text{cm}^2/\text{V.s}</td>
</tr>
</tbody>
</table>

Results and discussion

Current-voltage characterization

The results are displayed directly on the screen of the bench and recorded. Figure (Fig. 2) shows the curve (I-V) of the sample Hg / n-GaN structure.

The latter applies a voltage (V) on the structure and directly measuring the current flowing there through.

The general shape of this curve is characteristic for a Schottky structure.

The observation of the curve shows that the contact obtained by Mercury on the n-GaN substrate is a solid rectifying contact.
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For the determination of the electrical parameters, we exploit the general formula of the current which is of the following form [8]:

\[
I = I_s \left( \exp \left( \frac{q(V - I R_s)}{n k T} \right) \right)
\]

where \( n \) is the ideality factor which is used to assess the quality of the metal semiconductor interface. The closer it is to 1 the characteristic of the current live will be close to the theoretical model, \( q \) is the electron charge (C), \( V \) is the applied voltage (V), \( k \) is the Boltzmann constant (1.3806·10^-23 Jk^-1), \( T \) is the temperature (in k) and \( I_s \) is the saturation current given by (2).

\[
I_s = S A^* T^2 \exp(-q \Phi_b/kT)
\]

where \( S \) is the area of contact, \( q \) the electron charge, \( T \) is the temperature, \( k \) is Boltzmann's constant, \( A^* \) is the Richardson's constant, \( \Phi_b \) the barrier height and \( n \) is the ideality factor the diode.

From (1), we can draw the sin curve \( \ln [I] \) as a function of bias voltage (V) (Figure 3).
The intersection of the interpolation line of the first linear region of the curve \( \ln[I] = f(V) \) with the axis common to determine the saturation current \( I_s \) and the ideality factor \( n \) of the structure.

The interpolation line has the equation \( Y = A + BX \), and that in the first region, with [9]:

\[
B = \frac{q}{nkT} \quad (3)
\]

\[
A = \ln[I_s] \quad (4)
\]

The value of the saturation current \( I_s \) obtained is \( 2.45 \times 10^{-7} \) A, there is greater value to current saturation thermionic, this indicates the presence of another current level of our structure.

For the ideality factor \( n \) which reflects the difference between the behavior of a perfect structure and a real structure, the value obtained is 1.13.

We can express the barrier height \( \Phi_b \) (originally zero polarization) by [9]:

\[
\Phi_b = -\frac{kT}{q} \ln \left( \frac{I_s}{SA^*T^2} \right) \quad (5)
\]

where \( A^* \) is the Richardson’s constant which is effectively equal to \( 26,438 \) A.cm\(^{-2}\).k\(^{-2}\)[5], \( S \) is the surface of the pin of mercury which is equal to \( 7.85 \times 10^{-3} \) cm\(^2\) and \( T \) is the temperature taken is equal to 300 k.
Replacing the value of the saturation current in the above equation, the value of $\Phi_B$ obtained is 0.65 eV.

According to the characteristics $\ln [I] = f (V)$ we remark that the effect of the series resistance $R_s$ cannot be neglected.

To calculate this parameter, we use the following equation [10]:

$$R_S = \Delta V/T$$

The estimated series resistance is 670 $\Omega$.

The intersection of the interpolation line of the first linear region of the curve $\ln [I] = f (V)$ with the axis common to determine the saturation current $I_s$ and the ideality factor $n$ of the structure.

**Capacitance-voltage characterization**

The following figure shows the characteristic (C-V) derived from measurements of the capacitance taken at 1 MHz. using a tester capacitance-voltage model "Keithley test system. 590 HP Scan".

The bench work automatically, it is constituted by an oscillator, phase detector, and a ramp generator, the whole is controlled by a computer connected via an interface card to the tester. The software adapted with the tester we facilitates handling, and the results are directly displayed on the monitor [7].

![Capacitance-voltage characteristic](image)

**Figure 4.** Characteristic capacitance-voltage of the Hg/n-GaN structure in high frequency (1MHz)
To calculate the diffusion voltage and doping we must trace the characteristic $1/C^2 = f(V)$ (Figure 5).

![Graph](image)

**Figure 5. Characteristics of Hg / n-GaN structure $1/C^2 = f(V)$ in high frequency**

The curve is obtained with the appearance of a straight line. Knowing the equation of the line obtained by linear filtering performed using the software "Origin", we obtained a diffusion voltage $V_d$ of the order of 1.11 V and a substrate doping $N_d$ $1.68 \times 10^{16}$ cm$^{-3}$.

For the potential barrier, the value of $V_d$ is introduced in (7) [11]:

$$\Phi_B = V_d + \frac{kT}{q} \ln\left(\frac{N_c}{N_d}\right)$$  \hspace{1cm} (7)

The value found of $\Phi_B$ is 1.24 V.

**Determining the density of interface states $N_{ss}$**

To evaluate the distribution of interface states $N_{ss}$ in the bandgap of the semiconductor (GaN) we calculated $N_{ss}(V)$ using the following expression [12]:

$$N_{ss}(V) = \frac{1}{q} \left[ \frac{\varepsilon_i}{\delta} (n(V) - 1) - \frac{\varepsilon_s}{W} \right]$$  \hspace{1cm} (8)

with $\varepsilon_i = 3.5\varepsilon_0$ the permittivity of the oxide layer (Ga$_2$O$_3$) and $\varepsilon_s = 9.5\varepsilon_0$ the permittivity of the semiconductor.

The thickness $\delta$ of the oxide is about 23 Å and $W$ is the depletion region which is of
the order of 2630 Å. and the variation of the ideality factor (n) based on the bias voltage (V) is derived from the following equation:

\[ n(V) = \frac{V}{(kT/q)} \ln\left( \frac{I}{I_0} \right) \tag{9} \]

In an n-type semiconductor, the energy of the interface states Ess with respect to bottom of the conduction band at the surface of the semiconductor is given by:

\[ E_C - E_{SS} = q\Phi_e - qV \tag{10} \]

This relationship expresses the variation of the energy density of interface states E_{SS} (referenced to the conduction band energy E_c) as a function of the bias voltage (V), resulting a variation of N_{SS} according to (E_c-E_{SS}):

\[ N_{SS} = 1.85 \times 10^{12} \text{ cm}^{-2} \text{ eV}^{-1} \text{ to } 1.46 \times 10^{14} \text{ cm}^{-2} \text{ eV}^{-1} \text{ in (E_c-0.39)}. \]

The determined value of \( N_{SS}(E) \) near the mid-gap is minimal was in the range of \( 1.85 \times 10^{12} \text{ cm}^{-2} \text{ eV}^{-1} \text{ in (E_c-0.60),}\) it has increased exponentially from \( 1.85 \times 10^{12} \text{ cm}^{-2} \text{ eV}^{-1} \text{ in (E_c-0.60),}\) to \( 1.46 \times 10^{14} \text{ cm}^{-2} \text{ eV}^{-1} \text{ in (E_c-0.39).}\) The low surface state density on the studied sample shows the electronic quality of interface.

**Conclusions**

In this study, a of bulk gallium nitride Schottky diode has been fabricated and the I–V and C–V characteristics of this structure have been investigated. The values of the ideality
factor, series resistance and barrier height have been calculated.

The electrical characterization (I-V) showed that our diode arranged a low saturation current but higher than the theoretical one due to the presence of other currents at our diode (tunneling current, leakage current), an ideality factor (n) is slightly greater than 1 because inhomogeneity of the surface of our diode.

The Characterization (C-V) shows the feasibility of electronic components with the bulk GaN. The barrier height determined by (I-V) is lower than that determined by (C-V) showing the thermionic effect plus other events (such as the tunneling leakage current).

Otherwise we observed the presence of a native oxide layer and an interface state density (N_{ss}) slightly higher when approaching the conduction band.

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References


